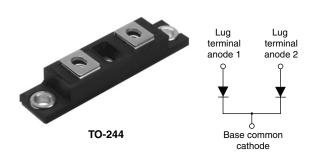


# Vishay High Power Products

# HEXFRED® Ultrafast Soft Recovery Diode, 167 A



PRODUCT SUMMARY				
I <sub>F</sub> (maximum)	167 A			
V <sub>R</sub>	600 V			
I <sub>F(DC)</sub> at T <sub>C</sub>	84 A at 100 °C			

#### **FEATURES**

- Very low Q<sub>rr</sub> and t<sub>rr</sub>
- Lead (Pb)-free
- · Designed and qualified for industrial level



ROHS

#### **BENEFITS**

- · Reduced RFI and EMI
- · Reduced snubbing

#### **DESCRIPTION**

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	$V_R$		600	V	
Continuous forward current		T <sub>C</sub> = 25 °C 167			
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 100 °C	84		
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	400		
Non-repetitive avalanche energy	E <sub>AS</sub>	$L = 100 \mu H$ , duty cycle limited by maximum $T_J$	330	μJ	
Maximum power dissipation P <sub>D</sub>		T <sub>C</sub> = 25 °C	310	w	
		T <sub>C</sub> = 100 °C	132	VV	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C	

<b>ELECTRICAL SPECIFICATIONS PER LEG</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	$V_{BR}$	Ι <sub>R</sub> = 100 μΑ		600	-	-	
		I <sub>F</sub> = 70 A		-	1.37	1.89	V
Maximum forward voltage V	$V_{FM}$	I <sub>F</sub> = 140 A	See fig. 1	-	1.58	2.1	
		I <sub>F</sub> = 70 A, T <sub>J</sub> = 125 °C		-	1.29	1.54	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = 480 V	See fig. 2	-	1.2	4	mA
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	See fig. 3	-	140	250	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane - 7.0 - nh			nH		

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## HFA140NJ60CPbF

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	) A/μs, V <sub>R</sub> = 30 V	-	33	-	
Reverse recovery time See fig. 5	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	80	120	ns
occ lig. o		T <sub>J</sub> = 125 °C	$I_{F} = 70 \text{ A}$	-	140	220	
Peak recovery current	T <sub>J</sub> = 25 °C	T <sub>J</sub> = 25 °C		-	8.5	15	Α
See fig. 6	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		-	14	25	
Reverse recovery charge	0	T <sub>J</sub> = 25 °C	dl <sub>F</sub> /dt = 200 A/μs V <sub>B</sub> = 200 V	-	340	900	nC
See fig. 7	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C	-	980	2300	nc	
Peak rate of recovery current	e of recovery current T <sub>J</sub> = 25 °C	T <sub>J</sub> = 25 °C	-	300	-	A/μs	
See fig. 8	dI <sub>(rec)M</sub> /dt	T <sub>J</sub> = 125 °C		-	220	-	ΑνμS

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature	range	T <sub>J</sub> , T <sub>Stg</sub>	- 55	-	150	°C	
Thermal resistance, junction to case	per leg	R <sub>thJC</sub>	-	-	0.38	°C/W K/W	
Thermal resistance, junction to case	per module		-	-	0.19		
Typical thermal resistance, case to heatsink		R <sub>thCS</sub> - 0.10		0.10	-	17/ 44	
Weight			-	68	-	g	
			-	2.4	-	OZ.	
Mounting torque (1)			30 (3.4)	-	40 (4.6)		
Mounting torque center hole			12 (1.4)	-	18 (2.1)	N ⋅ m (lbf ⋅ in)	
Terminal torque			30 (3.4)	-	40 (4.6)		
Vertical pull 2" lever pull			-	-	80	llef in	
			-	-	35	lbf ⋅ in	

#### Note

<sup>(1)</sup> Mounting surface must be smooth, flat, free or burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 - 10 lbf · in steps until desired or maximum torque limits are reached





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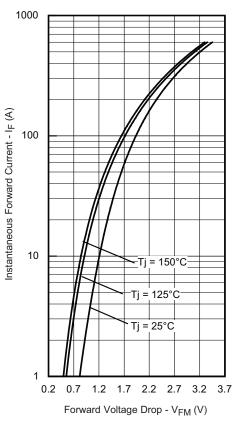


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

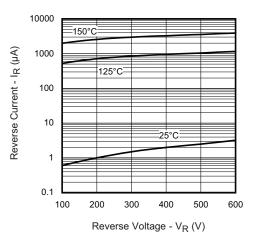


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)

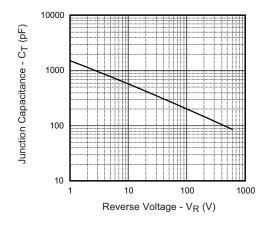


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

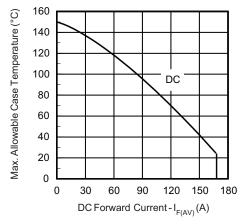


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

## HFA140NJ60CPbF

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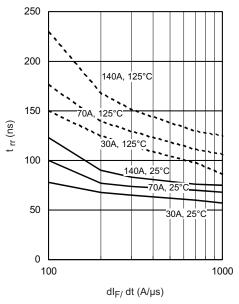


Fig. 5 - Typical Reverse Recovery Time vs.  $dI_F/dt$  (Per Leg)

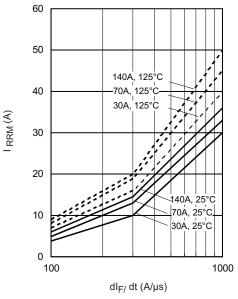


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt (Per Leg)

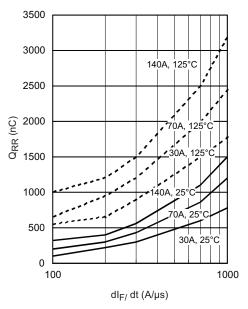


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt (Per Leg)

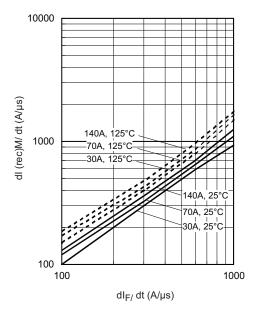


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$  (Per Leg)



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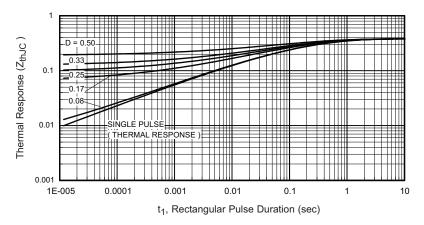


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

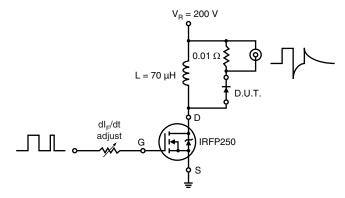
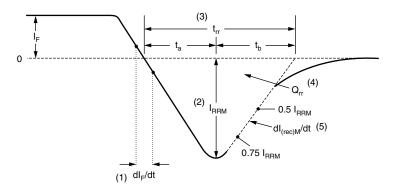


Fig. 10 - Reverse Recovery Parameter Test Circuit



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2)  $I_{RRM}$  peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.
- (4)  $\mathbf{Q}_{rr}$  area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{\text{RBM}}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5)  $dI_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 

Fig. 11 - Reverse Recovery Waveform and Definitions

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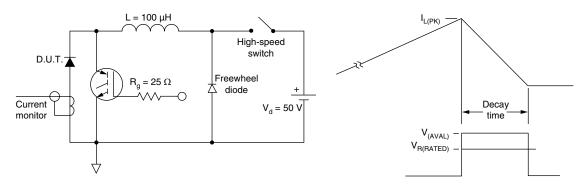


Fig. 12 - Avalanche Test Circuit and Waveforms

#### **ORDERING INFORMATION TABLE**

Device code

HFA 140 NJ 60 C PbF

1 2 3 4 5 6

1 - HEXFRED® family
2 - Average current rating

3 - NJ = TO-244

- Voltage rating (600 V)

5 - C = Common cathode

6 - Lead (Pb)-free

LINKS TO RELATED DOCUMENTS			
Dimensions	http://www.vishay.com/doc?95021		

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